

Information for treatment facilities		
Company Name	SEIKO EPSON	
Products Name	WP-4590	
Type of equipment	MFP (BIJ)	
Component or Material [EICTA,CECED and EERA Joint Position Guidance September 26,2005]	Judgment	Location No
Battery (internal*) containing Mercury (Hg)/ NiCad/ Lithium/ Other	no	
Backlighting Lamps of LCD/TFT or similar screens containing Mercury (Hg)	no	
Mercury (Hg) in other applications**	no	
Cadmium**	no	
Gas discharge Lamps	no	
Plastic containing brominated flame retardants other than in Printed Circuit Assemblies***	no	
Liquid Crystal Displays with surface greater than 100 cm ²	no	
Capacitors with PCB's	no	
Capacitors with substances of concern**** + height >25 mm, diameter >25mm or proportionately similar volume	no	
Asbestos	no	
Refractory ceramic fibers	no	
Radio-active substances	no	
Beryllium Oxide	no	
Other forms of Beryllium	no	
Gasses-which fall under Regulation(EC)2037/2000 and all hydrocarbons (HC).	no	
Components with pressurized gas which need special attention Pressure >1.5 bar	no	
Liquids if volume > 10cl (or equivalence in weight,e.g. for PCB,oil...)	no	
Mechanical components that store mechanical energy (i.e. springs) or equivalent parts which need special attention (diameter > 10mm and height > 25mm or proportionally similar volume and expanding)	yes	1,2,3

Blue area = Blue area the need for the location of the compartment/ substances within the product. When the location of a substance/ components is requested, it is at part level, e.g. main board, housing, etc.

* Internal means that batteries can only be removed by opening the product by means of (a) tool(s).

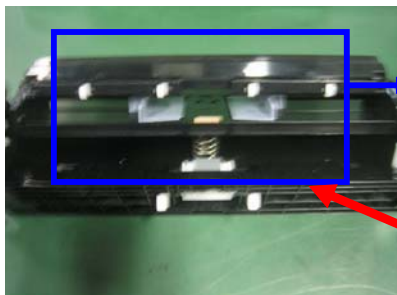
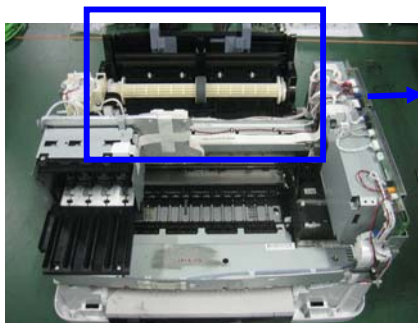
** Substances are considered to be in the product if present above the levels specified in Commission Decision 2005/618/EC related to Directive 2002/95/(EC) (RoHS Directive) or if their use is permitted through exemptions in the Annex of Directive 2002/

*** To be coherent with industry current standards and practices on tracking of plastic parts, Directive 2002/96 (EC) Annex II requirement is understood to focus on plastic parts that weight more than 25 g.

**** Substance of concern other than PCB, to be specified/ addressed further in the context of Directive 2002/96 (EC) Annex II national requirements and European developments.

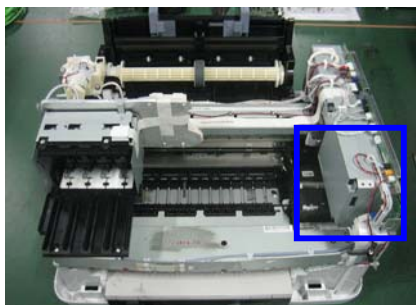
Location information	
Company Name	SEIKO EPSON
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Location No.1



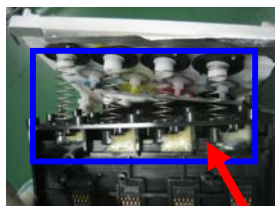
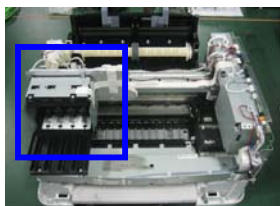
COMPRESSION SPRING2.7

Location No.2



COMPRESSION SPRING3.44

Location No.3



COMPRESSION SPRING2.67